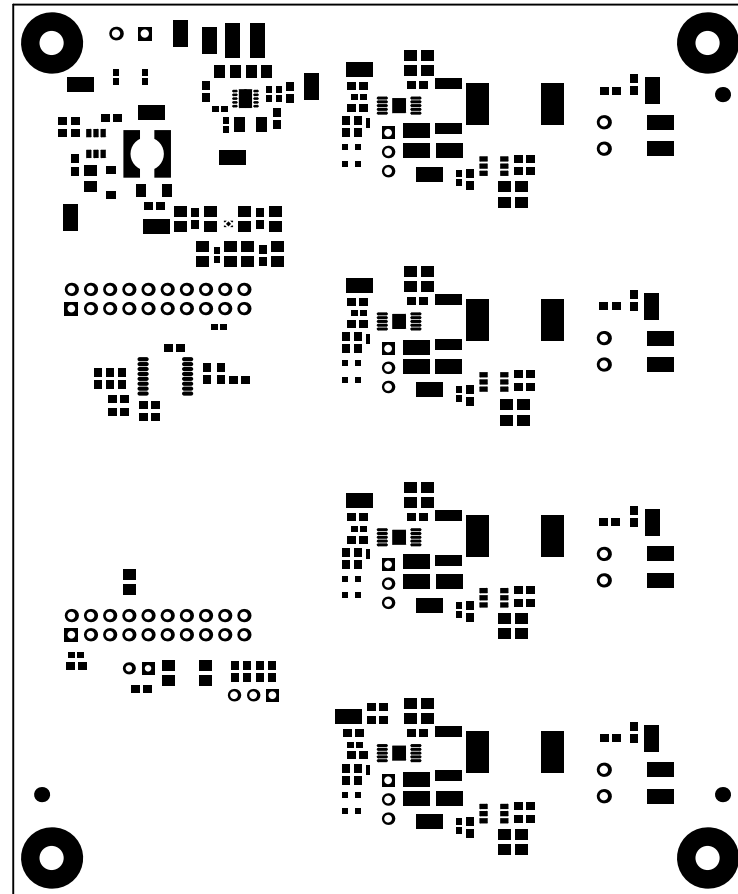
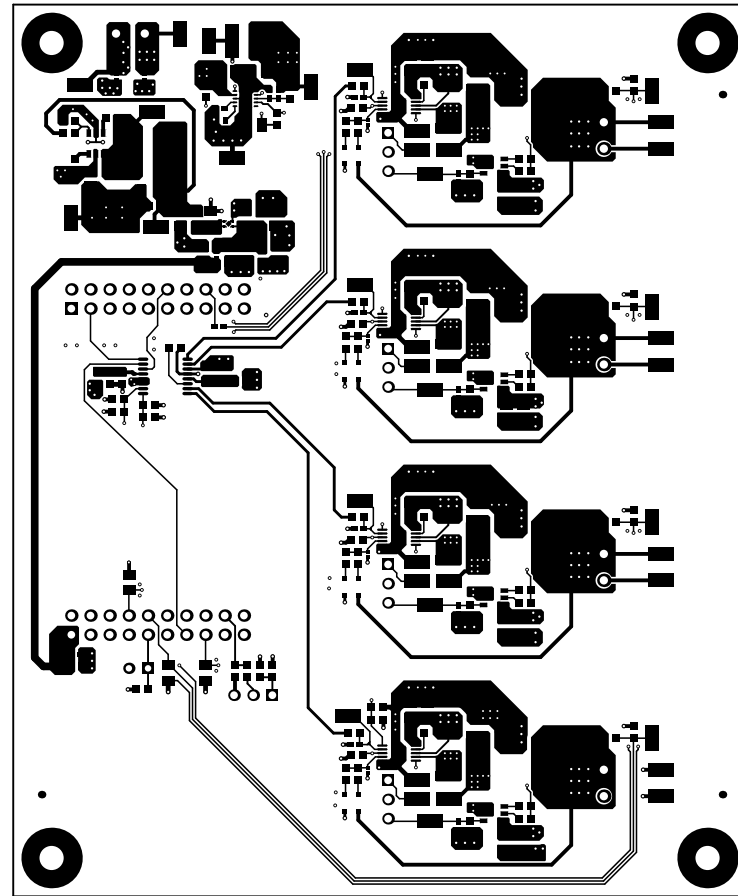


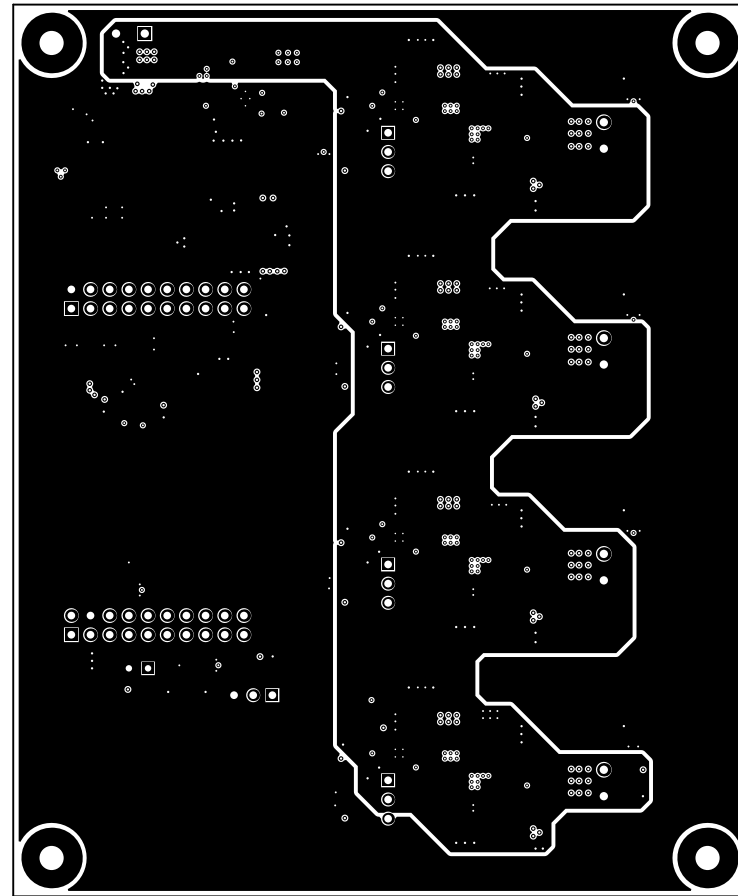
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01415		
PLOT NAME = Top Overlay	GENERATED : 4/26/2017	3:50:47 PM	TEXAS INSTRUMENTS



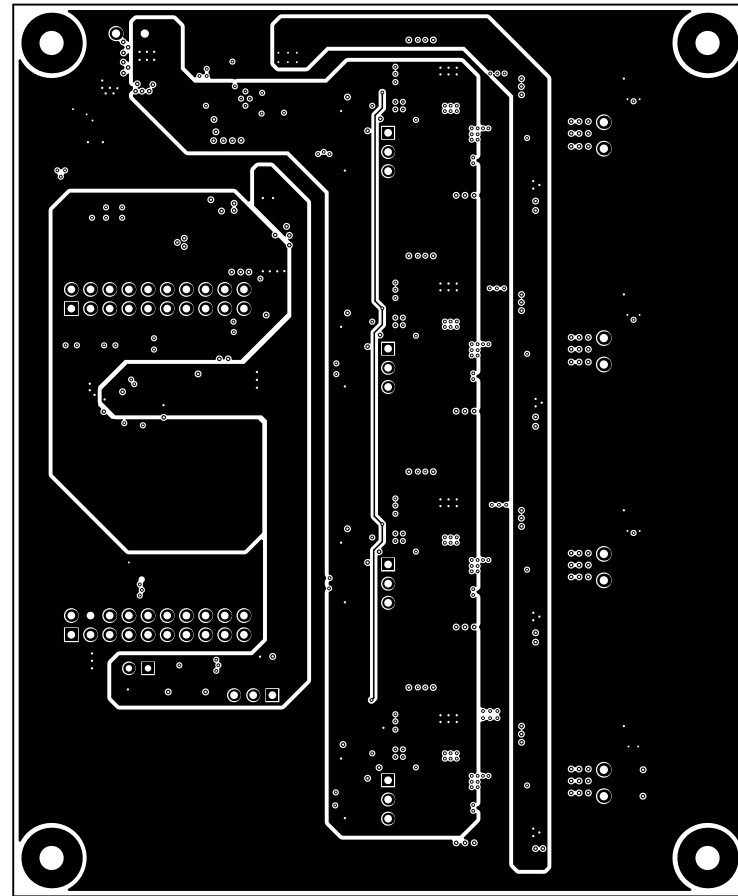
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01415		
PLOT NAME = Top Solder Mask	GENERATED : 4/26/2017	3:50:48 PM	TEXAS INSTRUMENTS



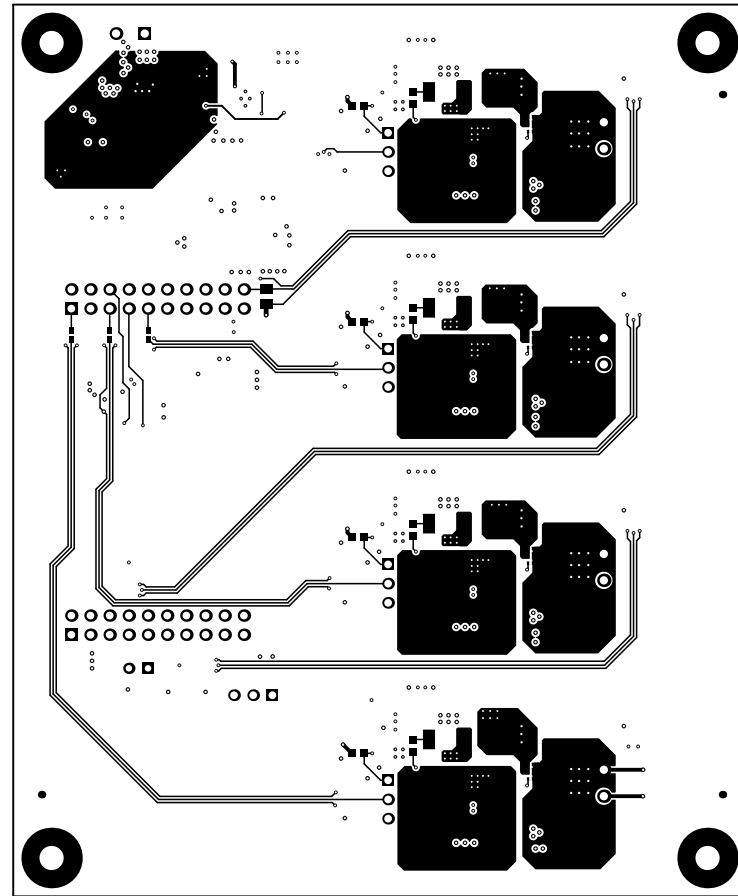
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01415		
PLOT NAME = Top Layer	GENERATED : 4/26/2017 3:50:49 PM	TEXAS INSTRUMENTS	



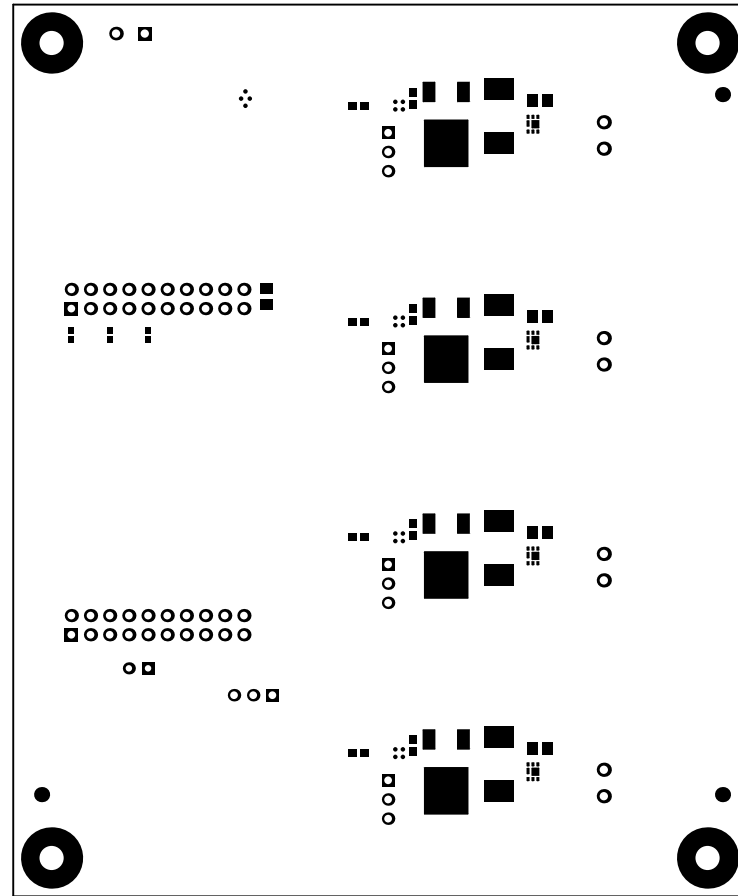
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = GND	TID #: TIDA-01415		
PLOT NAME = Signal Layer 1	GENERATED : 4/26/2017 3:50:50 PM	TEXAS INSTRUMENTS	



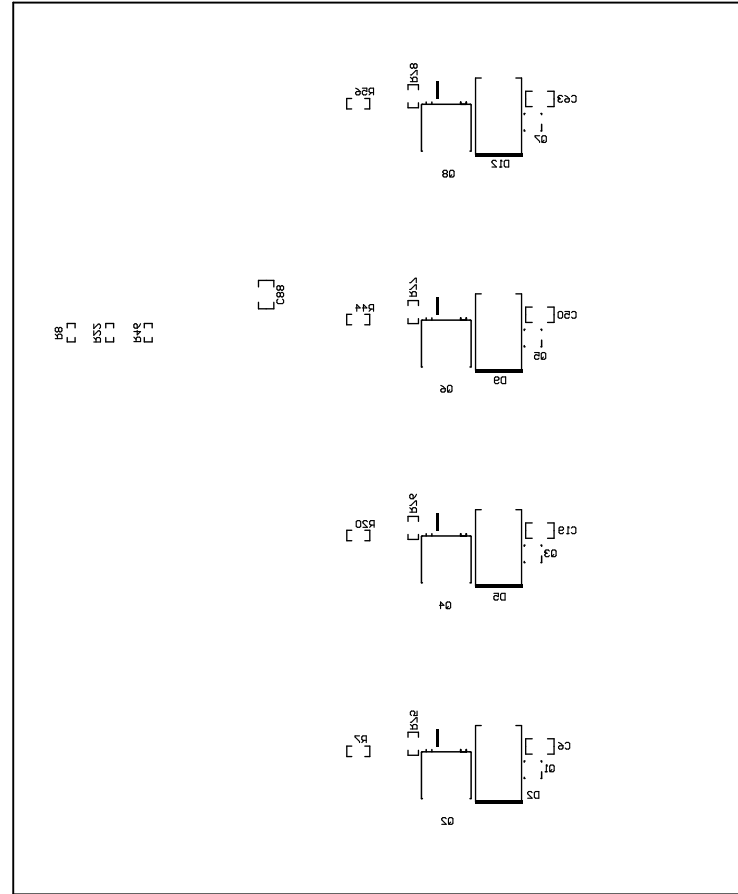
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = PWR	TID #: TIDA-01415		
PLOT NAME = Signal Layer 2	GENERATED : 4/26/2017 3:50:51 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01415		
PLOT NAME = Bottom Layer	GENERATED : 4/26/2017 3:50:52 PM	TEXAS INSTRUMENTS	

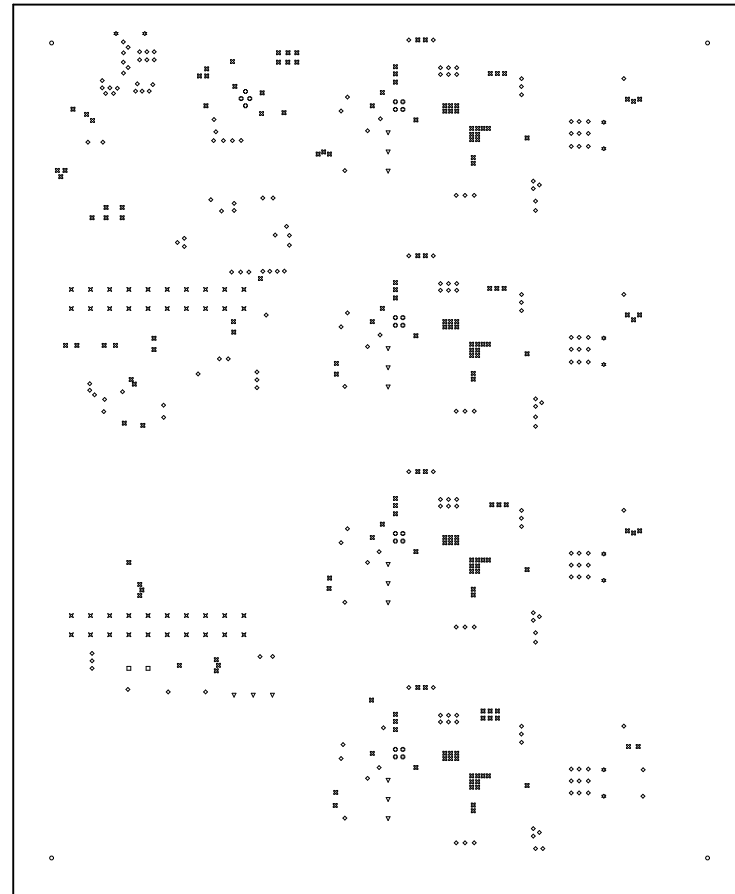


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01415		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/26/2017 3:50:53 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01415		
PLOT NAME = Bottom Overlay	GENERATED : 4/26/2017	3:50:53 PM	TEXAS INSTRUMENTS

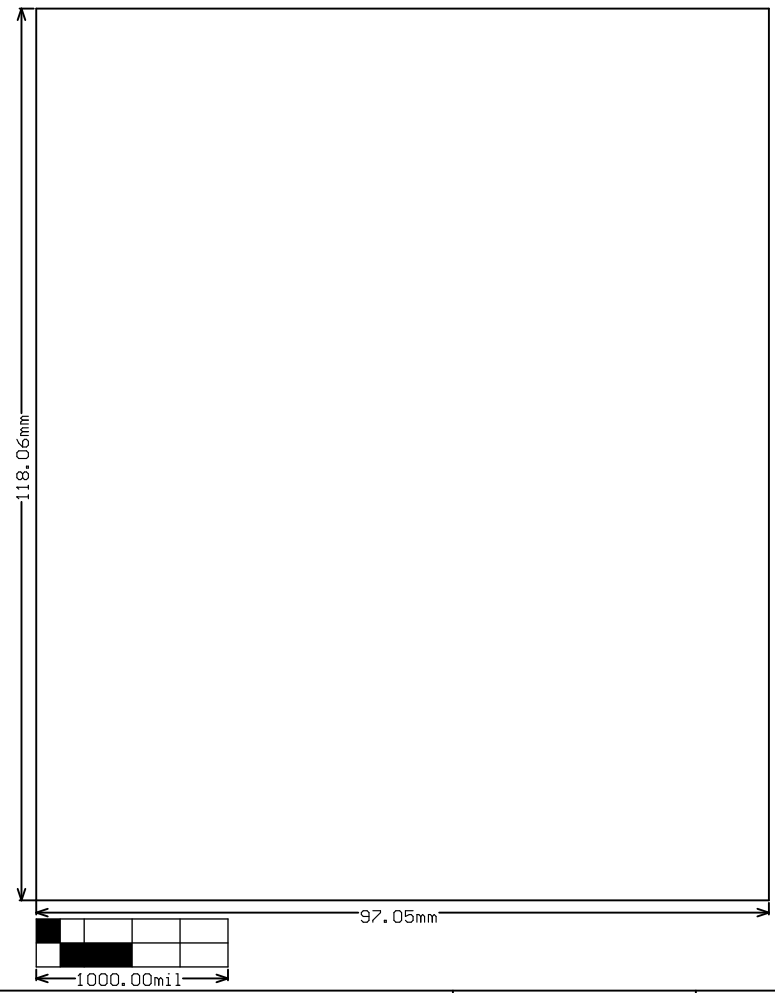




Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
⊙	20	7.87mil (0.200mm)	PTH	Round
⊗	182	10.00mil (0.254mm)	PTH	Round
◇	213	12.00mil (0.305mm)	PTH	Round
□	2	33.46mil (0.850mm)	PTH	Round
⊗	40	40.00mil (1.016mm)	PTH	Round
▽	15	40.16mil (1.020mm)	PTH	Round
☆	10	43.31mil (1.100mm)	PTH	Round
○	4	125.98mil (3.200mm)	PTH	Round
	486 Total			

DRILL TOLERANCE  
 FOR PTH +/- 3MIL  
 12mil drill:+0/-12mil  
 10mil drill:+0/-10mil  
 7.87mil drill:+0/-7.87mil  
 This is not an impedance controlled board  
 All vias are tented except the vias on thermal pad

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01415		
PLOT NAME = Drill Drawing	GENERATED : 4/26/2017	3:50:54 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01415	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01415		
PLOT NAME = Board Dimensions	GENERATED : 4/26/2017	3:50:56 PM	TEXAS INSTRUMENTS

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